

mju:wax® 2594

Product description micronised wax compound EINECS: preparation

mju:wax® 2594 is a micronised wax additive.

| Characteristic | Unit | Target value |
|----------------------------------|-------------------|--------------|
| Appearance | - | white powder |
| Drop point | °C | 118 |
| Particle size (D ₅₀) | μm | 7.0 |
| Particle size (D ₉₉) | μm | 20 |
| Acid value | mg KOH/g | 4 |
| Density (23°C) | g/cm ³ | 1.04 |

Major fields of application

mju:wax® 2594 is a micronised wax additive to get excellent matting properties combined with good transparency and silky touch. mju:wax® 2594 can be used alone without additional dosage of silica to achieve a high matting level. mju:wax® 2594 can be used in solvent or water based systems and is easy to stir in. mju:wax® 2594 provides very good scratch and abrasion resistance. Main applications are wood coatings, printing inks, OPV's as well as lacquers.

Packaging

Paper-bags of 20 kg netto.

Storage

The product has to be stored dry at room temperature.

Beware of sunlight and heat.

Stability at least 2 years from date of delivery.

Hazards

This product does not require labelling in terms of CLP/GHS guideline. Further security relevant data see safety data sheet.

Ecology/toxicology properties

The product is water insoluble. Further information see material safety data sheet.

Status under food legislation

The product fulfils legislations of various countries. More details on request.

All information given here are based on our own research or the research of others and believed to be accurate and shall give the user guidance for the application. Nevertheless these data are no specification and due to the versatile possible formulations, applications, processings and further parameters at the formulator/user the usage of this product has to be tested carefully in the particular system/application by the formulator/user. All information mentioned here are not warranted properties. There is no responsibility of the seller if the material is used outside the recommended field of use; any liability, also for any patent infringement, cannot be derived from this

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